

T-1 (3mm) SOLID STATE LAMP

PRELIMINARY SPEC

Part Number: L-10934VW1C/DR

White



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- Low power consumption.
- Popular T-1 diameter package.
- General purpose leads.
- Reliable and rugged.
- Long life solid state reliability.
- Available on tape and reel.
- RoHS compliant.

Description

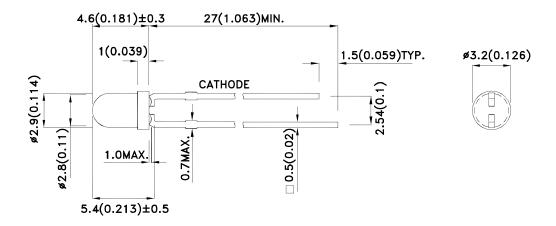
The source color devices are made with InGaN Light Emitting Diode.

Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
 4. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
L-10934VW1C/DR	White (InGaN)	Water Clear	8000	12000	20°

Notes:

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity/ luminous Flux: +/-15%.
 3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

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Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
VF [1]	Forward Voltage	White	3.3	4.0	٧	IF=20mA	
lR	Reverse Current	White		50	uA	V _R = 5V	
X [2]	Characticity Coordinates	White	0.31				
Y [2]	Chromaticity Coordinates		0.31				
С	Capacitance	White	100		pF	VF=0V;f=1MHz	

- 1. Forward Voltage: +/-0.1V.
- 2: Measurement Tolerance Of The Chromaticity Coordinates Is ±0.02.

Absolute Maximum Ratings at TA=25°C

Parameter	White	Units		
Power dissipation	120	mW		
DC Forward Current	30	mA		
Peak Forward Current [1]	100	mA		
Reverse Voltage	5	V		
Operating/Storage Temperature	-40°C To +85°C			
Lead Solder Temperature [2]	260°C For 3 Seconds			
Lead Solder Temperature [3]	260°C For 5 Seconds			

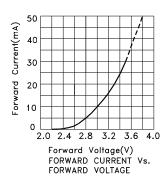
Notes:

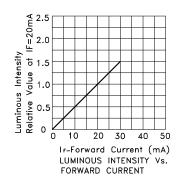
- 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base. 3. 5mm below package base.

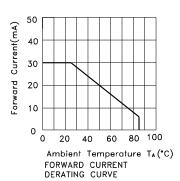
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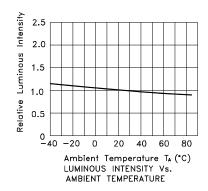
White

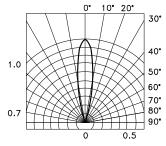
L-10934VW1C/DR









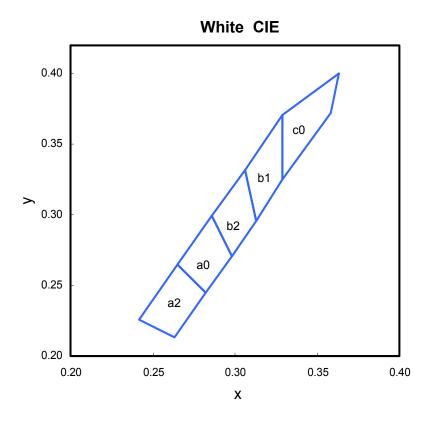


SPATIAL DISTRIBUTION

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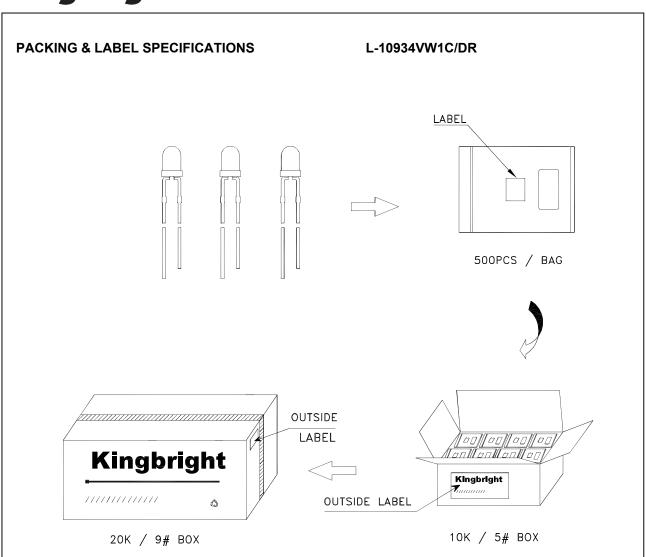
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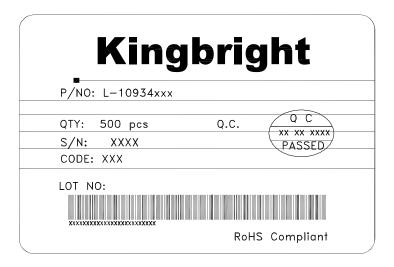


	x	у		x	у		x	у
a2	0.263	0.213	a0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

Notes: Shipment may contain more than one chromaticity regions. Orders for single chromaticity region are generally not accepted. Measurement tolerance of the chromaticity coordinates is ±0.02.

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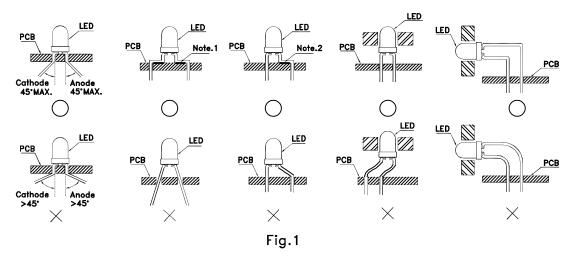




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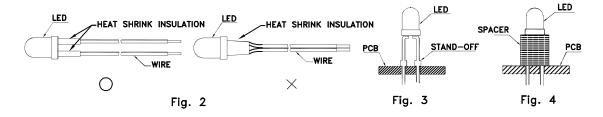
PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead—forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



" \bigcirc " Correct mounting method "imes" Incorrect mounting method

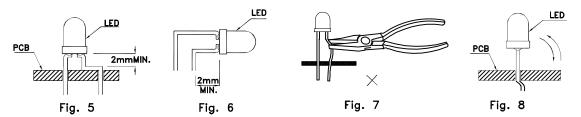
- 2. When soldering wire to the LED, use individual heat—shrink tubing to insulate the exposed leads to prevent accidental contact short—circuit. (Fig.2)
- 3.Use stand—offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



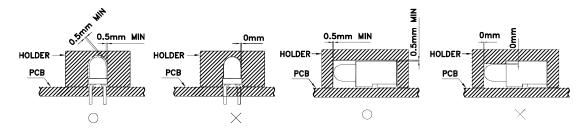
- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

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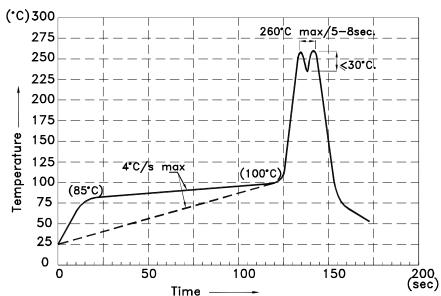
6. Do not bend the leads more than twice. (Fig. 8)



7. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- 8. The tip of the soldering iron should never touch the lens epoxy.
- 9. Through—hole LEDs are incompatible with reflow soldering.
- 10. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 11. Recommended Wave Soldering Profile for Kingbright Thru-Hole Products



Notes:

- 1. Recommend the solder wave peak temperature kept between 245~260°C, The maximum soldering temperature should not exceed 260°C.
- 2. Do not apply stress to the epoxy body while the temperature is above 85°C.
- 3. During the wave soldering process, the preheat temperature must not exceed 100°C.
- 4. Fixtures should not place stress on the component when mounted.
- 5. No more than one soldering pass.

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